



TSMC Reports Second Quarter EPS of NT\$1.32

Hsin-Chu, Taiwan, R.O.C., July 27, 2006 -- TSMC today announced consolidated revenue of NT\$82.12 billion, net income of NT\$34 billion, and fully diluted earnings per share of NT\$1.32 (US\$0.20 per ADS unit) for the second quarter ended June 30, 2006.

Year-over-year, second quarter revenue increased 36.9% while net income and fully diluted EPS increased 85.1% and 84.8%, respectively. On a sequential basis, second quarter results represent a 5.5% increase in revenue, and a 4.3% increase in net income and in fully diluted EPS. All figures were prepared in accordance with R.O.C. GAAP on a consolidated basis.

As a result of stronger demand in certain product segments, second quarter revenue reached beyond the high end of guidance. Advanced process technologies (0.13-micron and below) accounted for 49% of wafer revenues while revenues from 90-nanometer process technology alone was 24% of the total wafer sales. Gross margin rose from 48.5% in the previous quarter to 51.8% in the second quarter. Operating margin was 43% compared to 39.7% in the previous quarter, while net margin decreased slightly to 41.4% from 42% quarter over quarter.

“Driven primarily by sequentially stronger demand from our customers in communications and consumer segments, our second quarter business rose 5.5% amid weaker demand from our customers in the computer segment,” said Lora Ho, VP and Chief Financial Officer of TSMC. “Going forward, however, we expect the overall demand in the third quarter to be level or slightly down from the second quarter, in response to the correction of inventory in the supply chain,” said Ho. “Based on our current business outlook, management’s expectations for third quarter 2006 performance are as follows”:

- Revenue to be between NT\$79 billion and NT\$82 billion;
- Gross profit margin to be between 48% and 50%;
- Operating profit margin to be between 39% and 41%.

Conference Call & Webcast Notice:

TSMC’s quarterly review conference call will be held at 8 a.m. Eastern Time (8 p.m. Taiwan Time) on Thursday, July 27, 2006. The conference call will also be webcast live on the Internet. Investors wishing to access the live webcast should visit TSMC’s web site at <http://www.tsmc.com> at least 15 minutes prior to the broadcast. Instructions will be provided on the web site to facilitate the download and installation of necessary audio applications. Investors without Internet access may listen to the conference call, in listen-only mode, by dialing **1-617-786-2963** in the U.S., **852-3002-1672** in Hong Kong, **65-6823-2164** in Singapore, and **44-207-365-8426** in the U.K. (Password: TSMC). An archived version of the webcast will be available on TSMC’s web site for six months following the Company’s quarterly review conference call and webcast.

Profile

TSMC (TAIEX: 2330, NYSE: TSM) is the world's largest dedicated semiconductor foundry, providing the industry's leading manufacturing capacity, process technology, library and IP options, and other leading-edge foundry services. TSMC currently operates two twelve-inch wafer fabs, five eight-inch wafer fabs and one six-inch fab. The Company also has substantial capacity commitments at two wholly owned subsidiaries, WaferTech in the U.S. and TSMC (Shanghai) Company, Ltd. in China, and at a joint-venture fab, SSMC, in Singapore. TSMC is the first foundry to run 65-nanometer customer design prototype wafers. TSMC's corporate headquarters are in Hsin-Chu, Taiwan. More information about TSMC is available through the World Wide Web at <http://www.tsmc.com>.

(Management Report and Tables Follow)

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Safe Harbor Notice:

The statements included in this press release that are not historical in nature are "forward-looking statements" within the meaning of the "safe harbor" provisions of the Private Securities Litigation Reform Act of 1995. TSMC cautions readers that forward-looking statements are subject to significant risks and uncertainties and are based on TSMC's current expectations. Actual results may differ materially from those contained in such forward-looking statements for a variety of reasons including, among others, risks associated with cyclical and market conditions in the semiconductor industry; demand and supply for TSMC's foundry manufacturing capacity in particular and for foundry manufacturing capacity in general; intense competition; the failure of one or more significant customers to continue to place the same level of orders with us; TSMC's ability to remain a technological leader in the semiconductor industry; TSMC's ability to manage its capacity; TSMC's ability to obtain, preserve and defend its intellectual property rights; natural disasters and other unexpected events which may disrupt production; and exchange rate fluctuations. Additional information as to these and other risk factors that may cause TSMC's actual results to differ materially from TSMC's forward-looking statements may be found in TSMC's Annual Report on Form 20-F, filed with the United States Securities and Exchange Commission (the "SEC") on April 20, 2006, and such other documents as TSMC may file with, or submit to, the SEC from time to time. Except as required by law, we undertake no obligation to update any forward-looking statement, whether as a result of new information, future events, or otherwise.



2Q06

Quarterly Management Report
July 27, 2006**CONTACT**

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Topics in This Report

- Revenue Analysis
- Capacity
- Profit & Expense Analysis
- Financial Condition Review
- Cash Flow & CapEx
- Reconciliation of Consolidated and Unconsolidated Financial Results
- Recap of Recent Important Events & Announcements

Operating Results Review:**Summary:**

(Amounts are on consolidated basis and are in NT\$ billion except noted otherwise)

	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>	<u>QoQ</u>	<u>YoY</u>
EPS (NT\$ per com. shr.)	1.32	1.26	0.71	4.3%	84.8%
(US\$ per ADR unit)	0.20	0.20	0.11		
Consolidated Net Sales	82.12	77.85	59.98	5.5%	36.9%
Gross Profit	42.50	37.73	24.25	12.6%	75.2%
Gross Margin	51.8%	48.5%	40.4%		
Operating Expense	(7.18)	(6.82)	(7.04)	5.1%	1.9%
Non-Operating Items ⁽¹⁾	0.95	3.62	0.69	(73.8%)	37.7%
Consolidated Net Income	34.00	32.61	18.37	4.3%	85.1%
Net Profit Margin	41.4%	41.9%	30.6%		
Wafer Shipment (kpcs 8 inch-equiv.)	1,869	1,738	1,275	7.5%	46.6%

(1) Includes cumulative effects of change in accounting principle.

Remarks:

The second quarter consolidated EPS of NT\$1.32 represents an 84.8% increase over the same period last year and a 4.3% sequential increase. The consolidated operating results of 2Q06 are summarized below:

Second quarter net sales increased by 36.9% year-over-year to reach NT\$82.12 billion compared to NT\$59.98 billion reported in 2Q05. On a sequential basis, net sales increased by 5.5% compared to NT\$77.85 billion reported in the previous quarter. Growth was driven by strong demand in the consumer and communication segments.

Gross profit for 2Q06 was NT\$42.5 billion, representing a year-over-year increase of 75.2% and a sequential increase of 12.6%. Gross margin rose from 48.5% in the previous quarter to 51.8% in the second quarter, an improvement of 3.3 percentage points.

Operating expenses were NT\$7.18 billion or 8.8% of the net sales. The combined result from non-operating income and long-term investments was a gain of NT\$0.95 billion.

Consolidated net income attributable to shareholders of the parent company was NT\$34 billion, up 85.1% over the same period last year and up 4.3% sequentially. Net profit margin was 41.4%.

I. Consolidated Revenue Analysis

I. Wafer Sales Analysis

By Application	2Q06	1Q06	2Q05
Computer	30%	37%	38%
Communication	44%	39%	37%
Consumer	20%	18%	18%
Industrial/Others	5%	5%	6%
Memory	1%	1%	1%

By Technology	2Q06	1Q06	2Q05
N90-	24%	20%	2%
0.11/0.13um	25%	29%	41%
0.15/0.18um	32%	32%	34%
0.25/0.35um	14%	14%	17%
0.50um+	5%	5%	6%

By Customer Type	2Q06	1Q06	2Q05
Fabless/System	72%	74%	74%
IDM	28%	26%	26%

By Geography	2Q06	1Q06	2Q05
North America	77%	78%	77%
Asia Pacific	10%	11%	9%
Europe	9%	7%	8%
Japan	4%	4%	6%

Consolidated Revenue Analysis:

Consolidated net sales were NT\$82.12 billion for 2Q06, mainly driven by strong demand from our customers in communication and consumer segments.

On a sequential basis, revenues from consumer and communication applications increased by 21% and 19%, respectively, while revenues from computer applications declined by 16%.

Revenue from advanced technologies (0.13-micron and below) accounted for 49% of total wafer sales, flat from the previous quarter. Revenue from 90nm process technology continued to increase and accounted for 24% of total wafer sales during the second quarter, compared to 20% in the first quarter of 2006.

IDM accounted for 28% of total wafer sales during the quarter, up from 26% in the previous quarter.

Geographically, North America accounted for 77% of total wafer sales. Meanwhile, sales from Asia Pacific, Europe and Japan accounted for 10%, 9% and 4% of wafer sales, respectively.

II. Capacity

II. Capacity					
Fab / (Wafer size)	1Q06 (A)	2Q06 (A)	3Q06 (Est.)	4Q06 (Est.)	2006 (Est.)
Fab-2 (6") ¹	244	258	258	266	1,025
Fab-3 (8")	246	252	265	258	1,021
Fab-5 (8")	135	138	147	153	573
Fab-6 (8")	215	222	233	248	918
Fab-7 (8")	33	23	4	0	60
Fab-8 (8")	231	233	234	248	946
Fab-12 (12") ²	142	150	157	166	616
Fab-14 (12") ²	61	66	86	105	318
Wafer Tech (8")	99	100	101	104	404
TSMC (Shanghai) (8")	48	52	73	90	262
TSMC total capacity (8" equiv. Kpcs)	1,602	1,650	1,748	1,860	6,860
SSMC (8")	49	50	51	52	202
Total managed capacity (8" equiv. Kpcs)	1,651	1,700	1,799	1,912	7,062

Note: 1. Figures represent number of 6" wafers. Conversion to 8"-equivalent wafers is by dividing this number by 1.78

2. Figures represent number of 12" wafers. Conversion to 8"-equivalent wafers is by multiplying this number by 2.25

Capacity:

Total TSMC managed capacity in 2Q06 was 1,700K 8-inch equivalent wafers, 3% higher than the 1,651K 8-inch equivalent wafers in 1Q06.

TSMC managed capacity in 3Q06 will increase to 1,799K 8-inch equivalent wafers, representing a 5.8% sequential growth.

Overall installed capacity for year 2006 is expected to be approximately 7,062K 8-inch equivalent wafers, representing a slight increase from our previous forecast provided in April 2006.

III. Consolidated Profit & Expense Analysis

III - 1. Consolidated Gross Profit Analysis			
(Amount: NT\$ billion)	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>
COGS	39.6	40.1	35.7
Depreciation	16.5	16.2	17.5
Other MFG Cost	23.1	23.9	18.2
Gross Profit	42.5	37.7	24.3
Gross Margin	51.8%	48.5%	40.4%

Consolidated Gross Profit Analysis:

Consolidated gross profit for the second quarter of 2006 was NT\$42.5 billion, representing a year-over-year increase of 75.2% and a sequential increase of 12.6%. Consolidated gross margin improved by 3.3 percentage points sequentially to 51.8%, largely due to higher levels of wafer output and productivity improvements.

III - 2. Consolidated Operating Expenses *

(Amount: NT\$ billion)	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>
Total Operating Exp.	7.18	6.82	7.04
SG&A	3.13	3.04	3.48
Research & Development	4.05	3.78	3.56

* Certain prior period amounts have been reclassified to conform with current period presentation.

III - 3. Consolidated Non-Operating Items *

(Amount: NT\$ million)	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>
Non-Operating Income/(Exp.)	299	1,417	464
Net Interest Income/(Exp.)	924	775	268
Other Non-Operating	(625)	642	196
L-T Investments	650	600	226
SSMC	471	462	140
Others	179	138	86
Change in Accounting Principle **	0	1,607	0
Total Non-Operating Items	949	3,624	690

* Certain prior period amounts have been reclassified to conform with current period presentation.

** For financial statement purposes, cumulative effect of changes in accounting principles is presented as a separate line item after income tax expenses.

Consolidated Operating Expenses:

Consolidated operating expenses for 2Q06 were NT\$7.18 billion, slightly higher than the previous quarter. Higher operating expenses were largely the result of increased R&D expenditures on various 65nm projects. Total operating expenses represented 8.8% of net sales, flat from the previous quarter.

Consolidated Non-Operating Items:

Combined result from non-operating income and long-term investments was a gain of NT\$949 million for 2Q06.

Consolidated non-operating income totaled NT\$299 million during the second quarter of 2006, compared to an income of NT\$1,417 million in the previous quarter. The decrease in non-operating income was mainly due to the mark-to-market adjustment recorded as a result of the decline in the market value of certain marketable securities held through TSMC venture capital funds.

Consolidated net investment income was NT\$650 million in this quarter, compared to an income of NT\$600 million in 1Q06. The increase was primarily due to improved operating performance at TSMC's affiliates.

During the first quarter of 2006, TSMC adopted SFAS No. 34, which requires marketable securities with readily determinable market value measured at fair value with unrealized gains and losses on trading securities recognized in earnings for the current period. As a result of adopting SFAS No. 34, TSMC recognized a one-time gain of NT\$1.6 billion in 1Q06 as the cumulative effect of changes in accounting principles.

IV. Financial Condition Review

IV - 1. Liquidity Analysis *			
(Amount: NT\$ Billion)	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>
Cash & Marketable Securities	211.6	192.3	138.1
Accounts Receivable - Trade	38.0	38.0	32.1
Inventory	20.1	18.4	15.2
Total Current Assets	279.7	259.3	194.0
Accounts Payable	27.5	22.4	19.0
Accrued Liabilities and Others	82.8	18.5	71.1
Total Current Liabilities	110.3	40.9	90.1
Current Ratio (x)	2.5	6.3	2.2
Net Working Capital	169.4	218.4	103.9

* Certain prior period amounts have been reclassified to conform with current period presentation.

IV - 2. Consolidated Receivable/Inventory Days			
	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>
Days of Receivable	44	46	48
Days of Inventory	47	44	41

IV - 3. Consolidated Debt Service *			
(Amount: NT\$ Billion)	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>
Cash & Marketable Securities	211.6	192.3	138.1
Interest-Bearing Debt	27.2	27.2	37.6
Net Cash Reserves	184.4	165.1	100.5

* Certain prior period amounts have been reclassified to conform with current period presentation.

Liquidity Analysis:

Consolidated cash & marketable securities increased by NT\$19.3 billion in this quarter, mainly due to strong cash flows from operating activities. As a result, TSMC ended the quarter with total current assets of NT\$279.7 billion, NT\$20.4 billion higher than the previous quarter.

Consolidated current liabilities were NT\$110.3 billion at the end of the quarter, NT\$69.4 billion higher than the previous quarter, mainly due to an NT\$65 billion payable accrued for cash dividends and employee bonuses.

As a result, net consolidated working capital decreased to NT\$169.4 billion and current ratio decreased to 2.5x.

Consolidated Receivable/Inventory Days Trend:

Consolidated days of receivable decreased to 44 days in 2Q06, compared to 46 days in the previous quarter.

Consolidated days of inventory increased to 47 days from 44 days in the first quarter of 2006.

Consolidated Debt Service:

As a result of strong operating performance during the quarter, consolidated net cash reserves - defined as the excess of cash and short-term marketable securities over interest-bearing debt - increased by NT\$19.3 billion to NT\$184.4 billion in 2Q06.

Consolidated interest-bearing debt remained flat at NT\$27.2 billion as of June 30, 2006.

V. Cash Flow & CapEx

V - 1. Consolidated Cash Flow Analysis			
(Amount: NT\$ billion)	<u>2Q06</u>	<u>1Q06</u>	<u>2Q05</u>
Net Income	34.0	32.6	18.4
Depreciation & Amortization	17.9	17.7	19.5
Other Op Sources/(Uses)	(1.5)	(1.4)	(9.3)
Total Op Sources/(Uses)	<u>50.4</u>	<u>48.9</u>	<u>28.6</u>
Capital Expenditure	(21.4)	(11.5)	(14.2)
Marketable Financial Instruments	(7.8)	(12.8)	2.8
Other Investing Sources/(Uses)	(1.1)	0.2	(0.4)
Net Investing Sources/(Uses)	<u>(30.3)</u>	<u>(24.1)</u>	<u>(11.8)</u>
Repayment of Corporate Bonds	(0.0)	(0.0)	(0.9)
Other Financing Sources/(Uses)	0.1	0.1	0.9
Net Financing Sources/(Uses)	<u>0.1</u>	<u>0.1</u>	<u>(0.0)</u>
Net Cash Position Changes	20.2	24.9	16.8
Exchange Rate Changes & Others	(0.0)	(0.2)	0.1
Ending Cash Balance	141.5	121.3	88.4

* Certain prior period amounts have been reclassified to conform with the current period presentation.

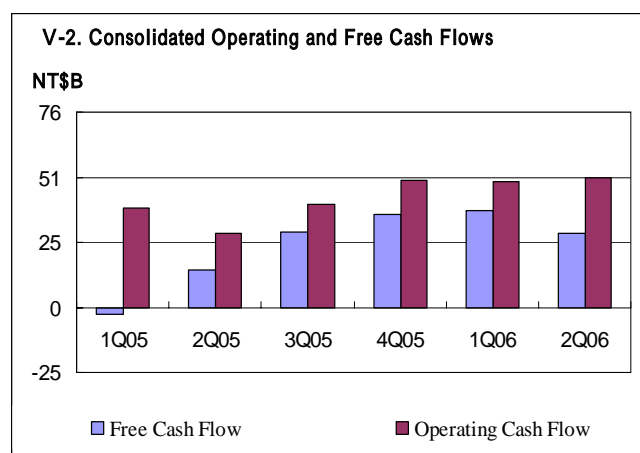
Summary of Consolidated Cash Flow:

During this quarter, TSMC generated NT\$50.4 billion from operating activities, mainly from net income of NT\$34 billion and depreciation & amortization of NT\$17.9 billion.

Net cash used in investment activities totaled NT\$30.3 billion, mainly as a result of an NT\$21.4 billion in capital spending and an NT\$7.8 billion net increase in marketable financial instruments.

Net cash provided by financing activities was NT\$0.1 billion during this quarter.

As a result, TSMC ended the quarter with a cash balance of NT\$141.5 billion, NT\$20.2 billion higher than in 1Q06.



Consolidated Operating and Free Cash Flows:

TSMC continues to generate strong free cash flows. Consolidated free cash flows totaled NT\$29 billion in 2Q06, NT\$8.4 billion lower than the NT\$37.4 billion generated in the previous quarter, mainly due to higher level of capital expenditures in 2Q06.

V - 3. Capital Spending			
(Amount: US\$ Million)	<u>1Q06</u>	<u>2Q06</u>	<u>YTD</u>
TSMC	344	653	997
TSMC (Shanghai) & WaferTech	<u>12</u>	<u>11</u>	<u>23</u>
Total TSMC	356	664	1,020

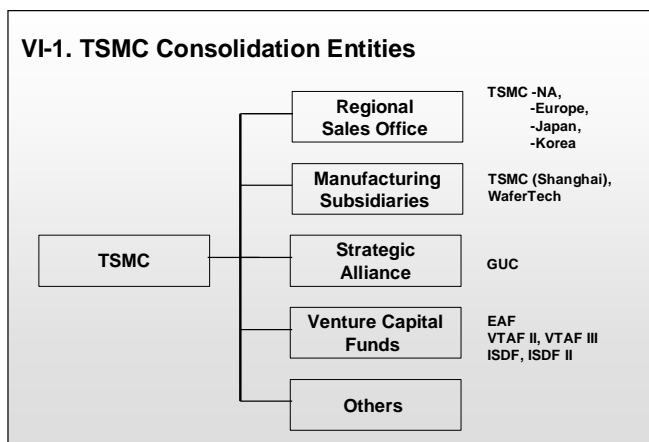
Capital Spending:

Capital spending for TSMC consolidated group totaled US\$664 million during the quarter. Most of the spending was for the purchase of 12-inch production equipment.

For year 2006, total capital expenditure for TSMC consolidated group is expected to be in the range of US\$2.6 billion to US\$2.8 billion, unchanged from our previous guidance provided in January 2006.

VI. Reconciliation of Consolidated and Unconsolidated Financial Results

VI-1. TSMC Consolidation Entities



VI - 2. Consolidated v. Unconsolidated Income Statement

(Amount: NTS billion)

	<u>Consolidated</u>	<u>Unconsolidated</u>	<u>Difference</u>
Net Sales	82.1	81.2	0.9
COGS	<u>(39.6)</u>	<u>(40.3)</u>	<u>0.7</u>
Gross Profit	42.5	40.9	1.6
Gross Margin %	51.8%	50.3%	1.4%
Operating Expenses			
Research & Development	(4.1)	(3.7)	(0.3)
SG&A	<u>(3.1)</u>	<u>(2.2)</u>	<u>(0.9)</u>
Total Operating Expenses	(7.2)	(5.9)	(1.3)
Operating Income	35.3	35.0	0.3
Operating Margin %	43.0%	43.1%	0.0%
Non-Operating Items	0.9	1.3	(0.3)
Income Tax Benefit (Expense)	(2.3)	(2.2)	(0.0)
Minority Interest	0.0	0.0	0.0
Net Income	<u>34.0</u>	<u>34.0</u>	<u>0.0</u>
Net Margin %	41.4%	41.9%	-0.5%

Consolidated Structure

TSMC consolidated results include the results from its overseas sales offices (TSMC North America, TSMC Europe, TSMC Japan and TSMC Korea), manufacturing subsidiaries (TSMC (Shanghai) and WaferTech), strategic alliance (Global Unichip Corp.), venture capital funds, and others. These entities are collectively referred to as “TSMC consolidating entities” hereafter.

Income Statement

Consolidated net sales for 2Q06 were NT\$82.1 billion, NT\$0.9 billion higher than the unconsolidated net sales. Higher consolidated net sales reflect sales contributions from TSMC consolidating entities. Consolidated gross margin was 51.8%, compared to 50.3% on the unconsolidated basis. The higher consolidated gross margin reflects the true gross margin from TSMC consolidating subsidiaries.

Consolidated operating expenses were NT\$7.2 billion for 2Q06, NT\$1.3 billion higher than the unconsolidated operating expenses. The higher consolidated operating expenses were mainly attributable to additional sales & marketing expenses from TSMC overseas sales offices and additional G&A and R&D expenses from other TSMC consolidating entities. Total consolidated operating expenses accounted for 8.8% of consolidated net sales, compared to 7.2% on the unconsolidated basis.

On a consolidated basis, the combined result from non-operating income and long-term investments was a gain of NT\$0.9 billion, NT\$0.3 billion lower than that on the unconsolidated basis. Higher unconsolidated gain from non-operating items reflects TSMC’s share of income from the consolidating subsidiaries.

Consolidated net income attributable to shareholders of the parent company was NT\$34 billion, same as that on the unconsolidated basis. Consolidated net margin was 41.4%, 0.5% lower than the unconsolidated net margin, reflecting higher consolidated net sales.

**VI - 3. Consolidated v. Unconsolidated Balance Sheet
(Selected Balance Sheet Items)**

(Amount: NT\$ billion)	<u>Consolidated</u>	<u>Unconsolidated</u>	<u>Difference</u>
Cash & Marketable Securities	211.6	195.9	15.7
Accounts Receivable - Trade	38.0	36.1	1.9
Inventory	20.1	18.4	1.7
Total Current Assets	279.7	259.9	19.8
Long-Term Investments	42.8	83.2	(40.4)
Fixed Assets, Net	251.1	223.2	27.9
Total Assets	593.7	581.6	12.1
Total Current Liabilities	110.3	107.2	3.1
L/T Interest-Bearing Debt	24.7	17.0	7.7
Total Liabilities	146.2	134.8	11.5
Total Equity	447.5	446.8	0.7

Balance Sheet

On a consolidated basis, as a result of higher cash and marketable securities, total current assets were NT\$279.7 billion, NT\$19.8 billion higher than the unconsolidated total current assets.

Consolidated long-term investments were NT\$42.8 billion for 2Q06, compared to NT\$83.2 billion on the unconsolidated basis. Higher unconsolidated long-term investments reflect TSMC's investments in its consolidating subsidiaries.

Consolidated net fixed assets totaled NT\$251.1 billion, NT\$27.9 billion higher than the unconsolidated net fixed assets, mainly due to manufacturing facilities located at TSMC's consolidating entities.

Total consolidated liabilities were NT\$146.2 billion, compared to NT\$134.8 billion on the unconsolidated basis, as total unconsolidated liabilities does not reflect the borrowings by TSMC's consolidating entities.

VI - 4. Consolidated v. Unconsolidated Cash Flows

(Amount: NT\$ billion)	<u>Consolidated</u>	<u>Unconsolidated</u>	<u>Difference</u>
Cash Flows Provided by Operating Activities	50.4	47.0	3.4
Depreciation & Amortization	17.9	16.2	1.7
Cash Flows Used in Investing Activities	(30.3)	(29.4)	(0.9)
Capital Expenditures	(21.4)	(21.1)	(0.3)
Cash Flows Provided by Financing Activities	0.1	0.1	(0.0)
Net Cash Increase (Decrease)	20.2	17.7	2.5

Cash Flows

Consolidated cash flows provided by operating activities were NT\$50.4 billion in 2Q06, NT\$3.4 billion higher than that on the unconsolidated basis, as consolidated operating cash flows included additional depreciation & amortization expenses from TSMC consolidating entities.

Consolidated cash flows used in investing activities totaled NT\$30.3 billion in 2Q06, slightly higher than that on the unconsolidated basis.

Consolidated cash flows provided by financing activities were NT\$0.1 billion in 2Q06, same as that on the unconsolidated basis.

VII. Recap of Recent Important Events & Announcements

- TSMC and ARM Collaboration Achieves Significant Power Reduction on First 65nm Low-Power Test Chip (2006/07/18)
- TSMC Continues Industry Leadership with Reference Flow 7.0 (2006/07/17)
- TSMC Bolsters Design Ecosystem with DFM-Compliant EDA Tools and Data Kit for 65nm Design (2006/07/17)
- TSMC Sets June 20, 2006 as the ex-Dividend Date for Common Share Dividend (2006/06/06)
- TSMC is Production-Ready for 65nm X Architecture Designs (2006/05/25)
- TSMC 65-Nanometer Process Moves to Volume Production (2006/05/17)
- TSMC Senior Vice President of R&D Dr. Shang-Yi Chiang to Retire (2006/05/17)
- TSMC Board of Directors Unanimously Re-elects Dr. Morris Chang as Chairman (2006/05/16)
- TSMC Shareholders Approve NT\$2.5 Cash and 3% Stock Dividend (2006/05/16)
- TSMC Unveils First 65-Nanometer Data-Driven DFM Design Ecosystem (2006/05/15)